



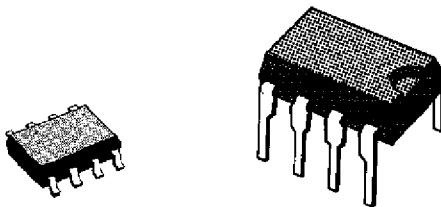
SGS-THOMSON
MICROELECTRONICS

THBT150
THBT200 / THBT270

TRISIL

FEATURES

- BIDIRECTIONAL TRIPLE PROTECTION
- CROWBAR PROTECTION
- PEAK PULSE CURRENT :
 $I_{PP} = 30 \text{ A}, 10/1000 \mu\text{s}$
- HOLDING CURRENT = 150 mA min
- AVAILABLE IN DIP 8 AND SO 8 PACKAGES



DESCRIPTION

Dedicated to telecommunication equipment protection, these devices provide a triple bidirectional protection function.

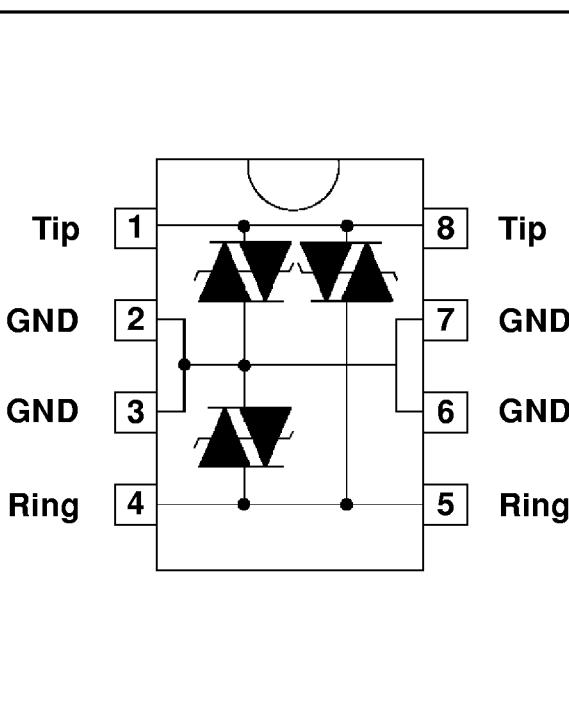
They ensure the same protection capability with the same breakdown voltage both in common mode and in differential mode.

Particular attention has been given to the internal wire bonding . A 4-point configuration ensures reliable protection, eliminating the overvoltage introduced by the parasitic inductances of the wiring (Ldi/dt) especially for very fast transients.

IN ACCORDANCE WITH FOLLOWING STANDARDS :

CCITT K17 - K20	{	10/700 μs	1.5 kV	
		5/310 μs	38 A	
VDE 0433	{	10/700 μs	2 kV	
		5/200 μs	50 A	
CNET	{	0.5/700 μs	1.5 kV	
		0.2/310 μs	38 A	

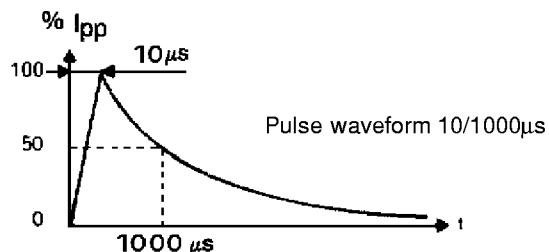
SCHEMATIC DIAGRAM



THBT150 / THBT200 / THBT270

ABSOLUTE RATINGS (limiting values) (-40°C ≤ T_{amb} ≤ +85°C)

Symbol	Parameter		Value	Unit
I _{PP}	Peak pulse current	10/1000 μs 5/320 μs 2/10 μs	30 40 75	A
I _{TSM}	Non repetitive surge peak on-state current	t _p = 10 ms t _p = 1 s	5 3.5	A
di/dt	Critical rate of rise of on-state current	Non repetitive	100	A/μs
dv/dt	Critical rate of rise of off-state voltage	67% V _{BR}	5	KV/μs
T _{stg} T _j	Storage and operating junction temperature range		- 40 to + 150 + 150	°C °C

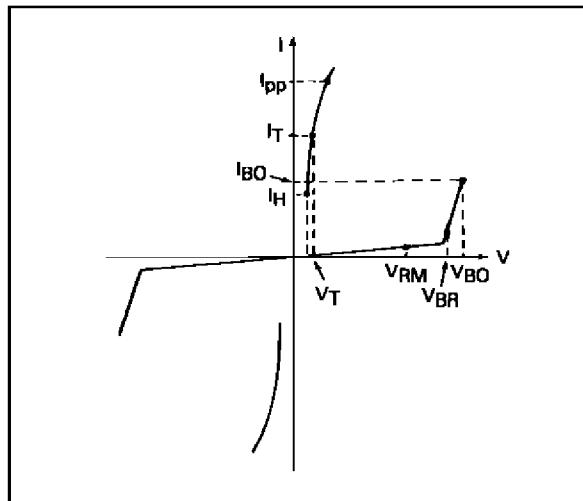


THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
R _{th} (j-a)	Junction-to-ambient	DIL 8 SO 8	125 171	°C/W °C/W

ELECTRICAL CHARACTERISTICS

Symbol	Parameter
V _{RM}	Stand-off voltage
V _{BR}	Breakdown voltage
V _{BO}	Breakover voltage
I _H	Holding current
V _T	On-state voltage
I _{BO}	Breakover current
I _{PP}	Peak pulse current



STATIC PARAMETERS

Types	I _R @ V _{RM}		V _{BR} @ I _R		V _{BO} @ I _{BO}			I _H	V _T	C
	max		min		max	min	max			
	μA	V	V	mA	V	mA	mA	mA	V	pF
THBT150	5	135	150	1	210	50	400	150	8	200
THBT200	5	180	200	1	290	50	400	150	8	200
THBT270	5	240	270	1	380	50	400	150	8	200

DYNAMIC PARAMETERS

Types	V _{BO} dyn Typical Value	
	note 4	
	(V)	
THBT150	290	
THBT200	380	
THBT270	420	

All parameters tested at 25°C, except where indicated

Note 1 : See the reference test circuit for I_H, I_{BO} and V_{BO} parameters.

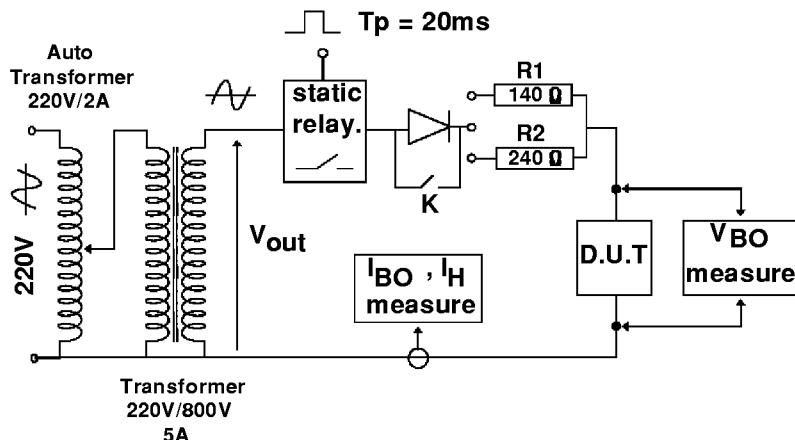
Note 2 : Square pulse T_p = 500 μs - I_T = 5A.

Note 3 : V_R = 1V, F = 1MHz.

Note 4 : The dynamic breakover voltage is measured with following surge test : CCITT - 1.5 KV 10/700 μs

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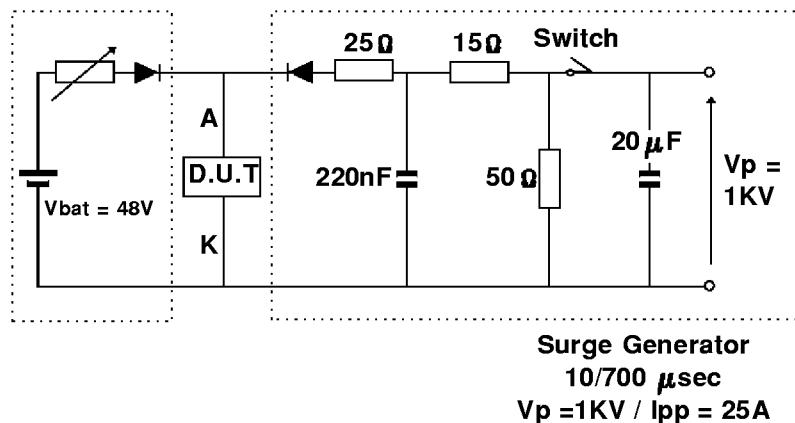
REFERENCE TEST CIRCUIT FOR I_H , I_{BO} and V_{BO} parameters :



TEST PROCEDURE :

- Pulse Test duration ($T_p = 20\text{ms}$):
 - For Bidirectional devices = Switch K is closed
 - For Unidirectional devices = Switch K is open.
- V_{out} Selection
 - Device with $V_{BR} \leq 150$ Volt
 - $V_{OUT} = 250\text{ V}_{RMS}$, $R_1 = 140\ \Omega$.
 - Device with $V_{BR} \geq 150$ Volt
 - $V_{OUT} = 480\text{ V}_{RMS}$, $R_2 = 240\ \Omega$.

FUNCTIONAL HOLDING CURRENT (I_H) TEST CIRCUIT = GO - NOGO TEST

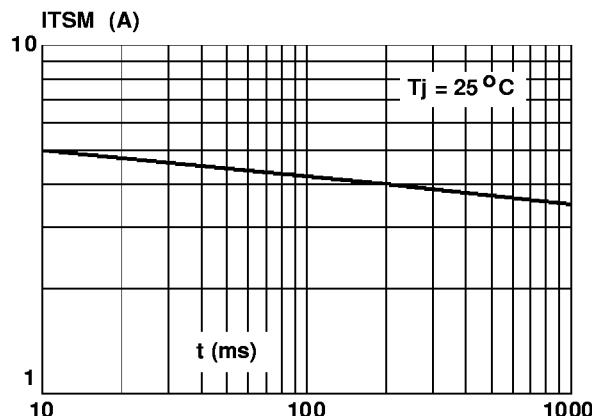


This is a GO-NOGO Test which allows to confirm the holding current (I_H) level in a functional test circuit. This test can be performed if the reference test circuit can't be implemented.

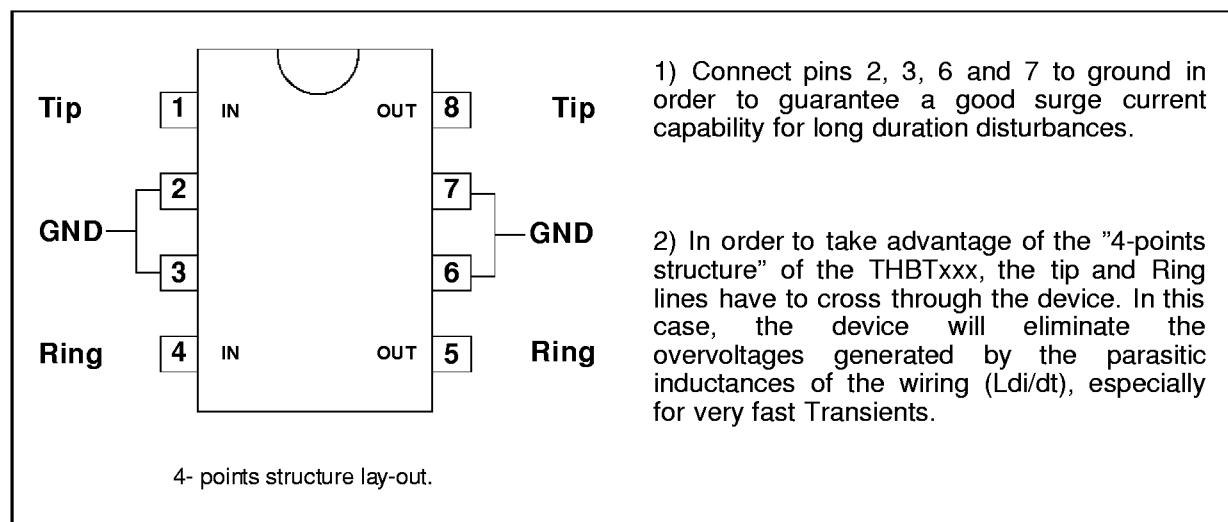
TEST PROCEDURE :

- 1) Adjust the current level at the I_H value by short circuiting the AK of the D.U.T.
- 2) Fire the D.U.T with a surge Current : $Ipp = 25\text{A}$, $10/700\ \mu\text{s}$.
- 3) The D.U.T will come back to the OFF-State within a duration of 50 ms max.

Figure 1 : Non repetitive surge peak on-state current. (with sinusoidal pulse : F =50Hz)



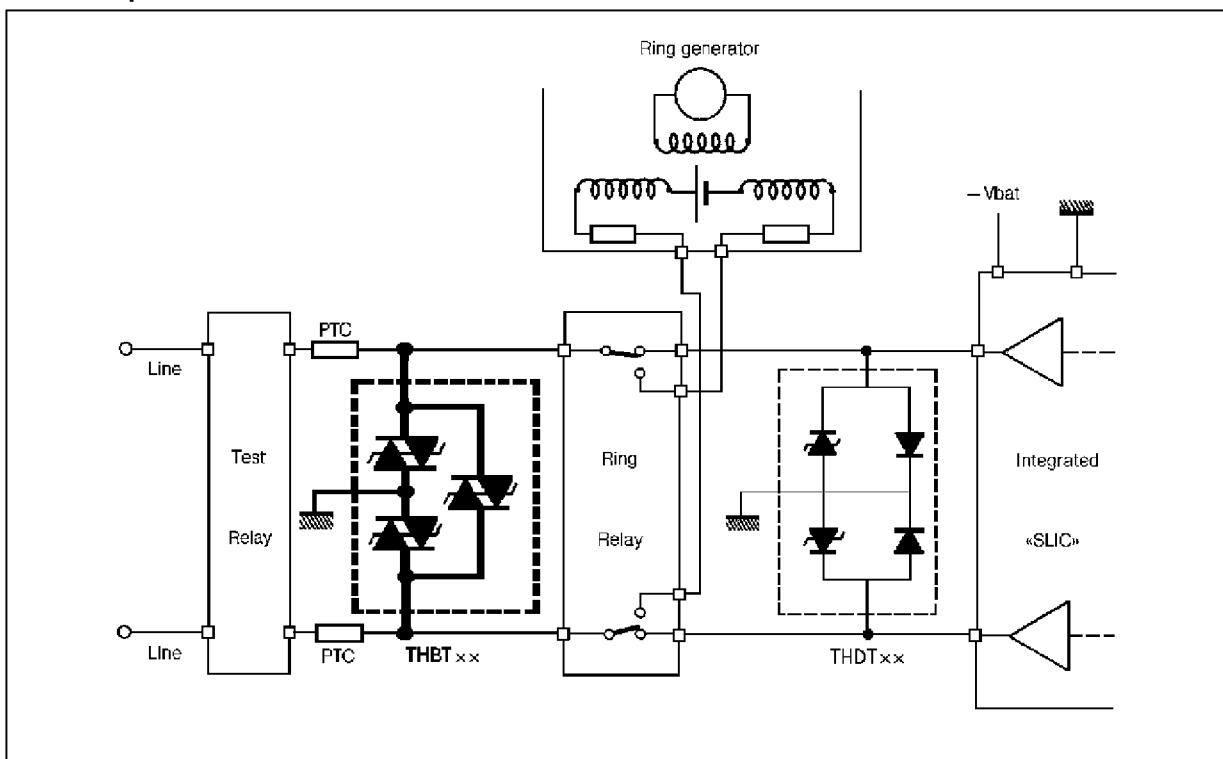
APPLICATION NOTE



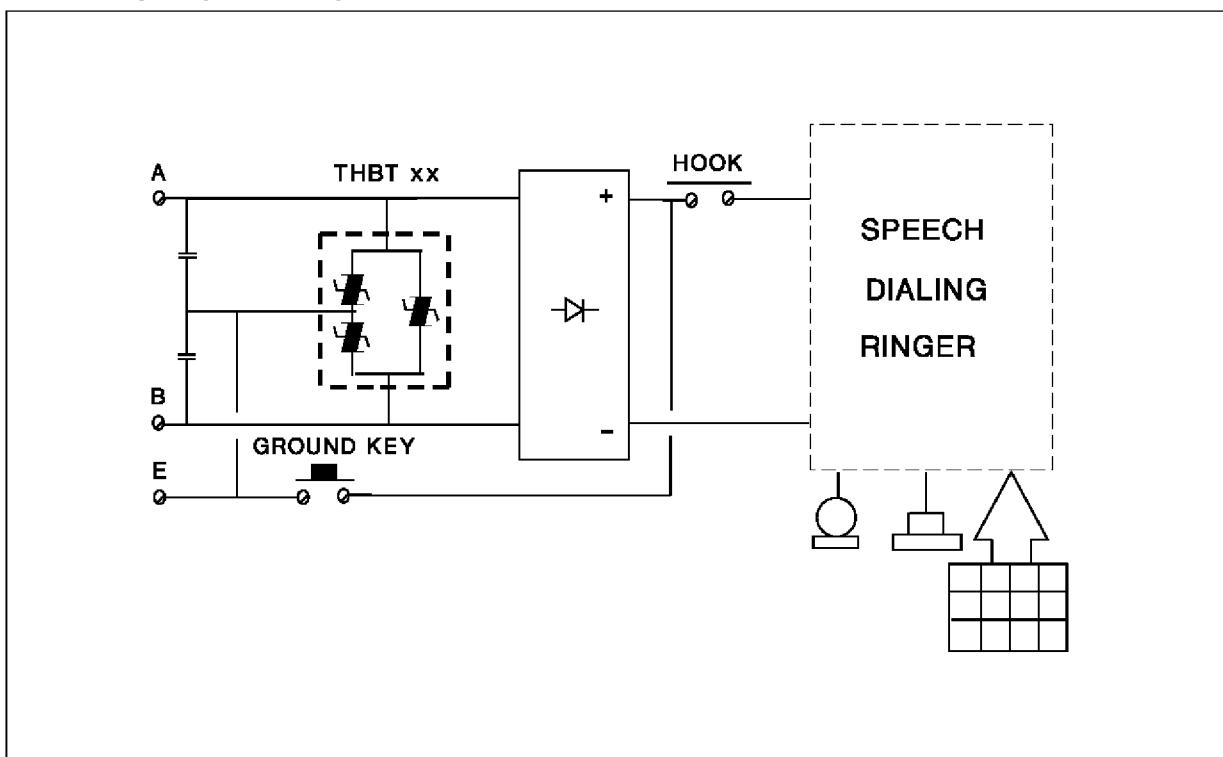
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APPLICATION CIRCUIT

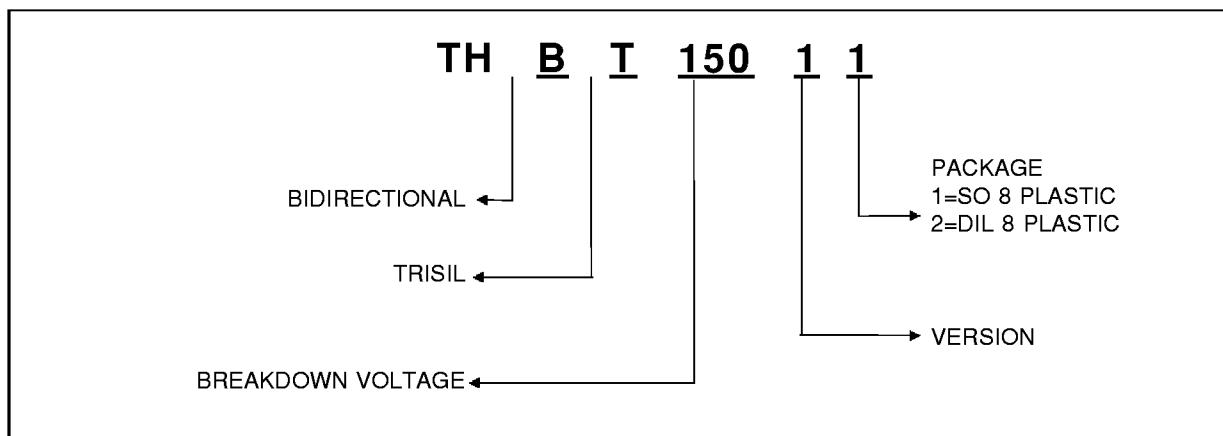
Line card protection



Ground key telephone set protection



ORDER CODE



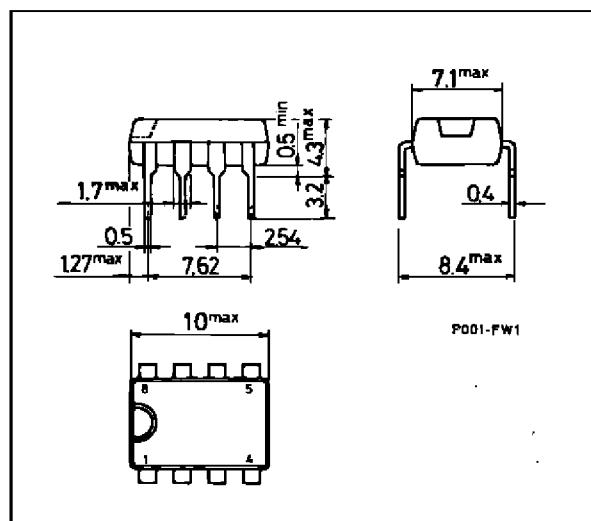
MARKING

Package	Type	Marking
SO8	THBT15011	BT1511
	THBT20011	BT2011
	THBT27011	BT2711

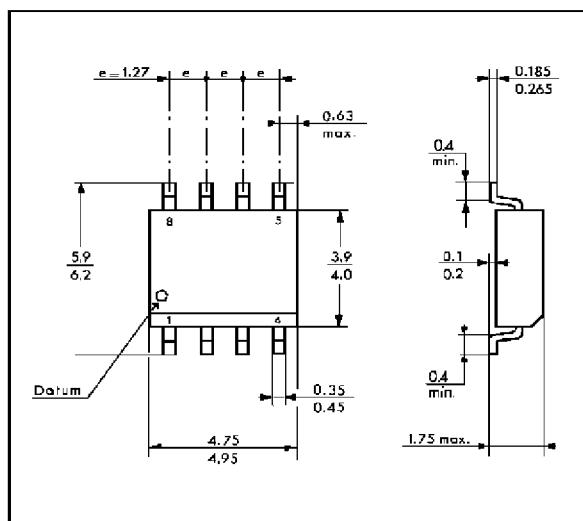
Package	Type	Marking
DIL8	THBT15012	BT1512
	THBT20012	BT2012
	THBT27012	BT2712

Packaging : Products supplied in antistatic tubes.

PACKAGE MECHANICAL DATA (in millimeters)
DIL 8 Plastic



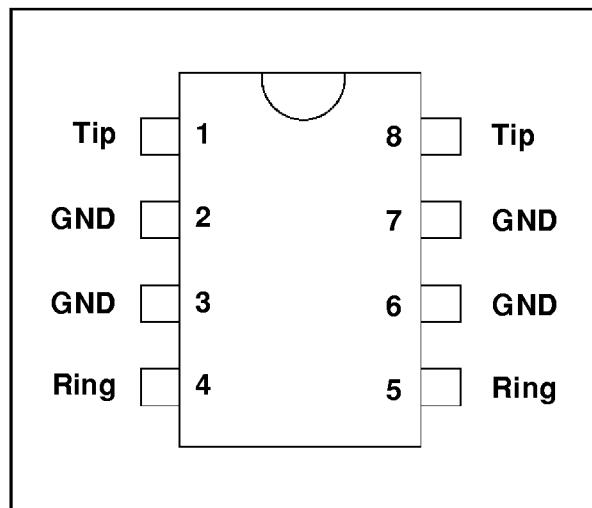
SO 8 Plastic



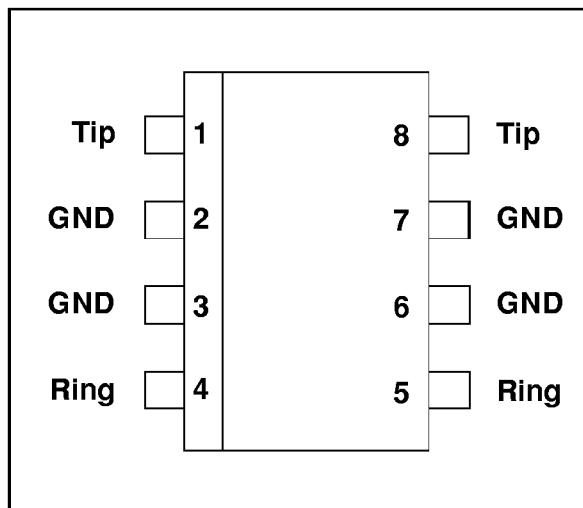
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CONNECTION DIAGRAM

DIL 8 Plastic



SO 8 Plastic



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